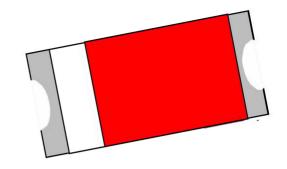
## 2.4GHz 5221 Chip Antenna: RANT5221F245M02

#### 1. Applications

WLAN, 802.11b/g, Bluetooth, WLAN, etc...



#### 2. Features

SMD, high reliability, ultra Impact, Omni-directional...

#### 3. Part Number Information

<u>RANT</u>	<u>5221</u>	<u>F</u>	<u>245</u>	<u>M</u>	<u>02</u>
(A)	(B)	(C)	(D)	(E)	(F)

(	, , , , , , , , , , , , , , , , , , , ,
(A)Product Type	Chip Antenna
(B) Size Code	5.0x2.0mm(±0.2mm)
(C) Material	High K material
(D) Frequency	2.4 ~ 2.5GHz
(E) Feeding mode	PIFA & Single Feeding
(F) Antenna type	Type=02

深圳市力同创科技有限公司 Shenzhen Li Tongchuang Technology Co., Ltd 深圳市宝安区银田街道银田路4号宝安智谷D栋409

Baoan Zhigu D Building 409, No. 4 Yintian Road, Yintian Street, Baoan District, Shenzhen

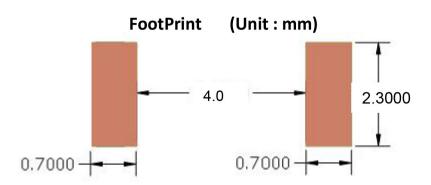
### 4. size

Figure	Symbol	Dimension (mm)
L	L (长)	5.00 ± 0.20
	<b>W</b> (宽)	2.00 ± 0.30
	T (厚度)	1.0 ± 0.30
Ā	A (电极宽度)	0.50± 0.20

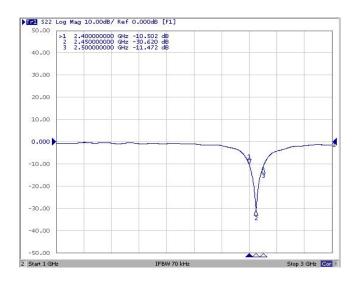
## 5. Electrical Specification

Specification			
Part Number	RANT 5221 F245 M02	2	
Central Frequency	2450	MHz	
Bandwidth	120 (Min.)	MHz	
Return Loss	-10 (Max)	dB	
Peak Gain	3.59	dBi	
Impedance	50	Ohm	
Operating Temperature	-40∼+85	$^{\circ}$ C	
Maximum Power	4	W	
Resistance to Soldering Heats	10 ( @ 260°C )	sec.	
Polarization	Linear		
Azimuth Beamwidth	Omni-directional		
Termination	Sn (Leadless)		

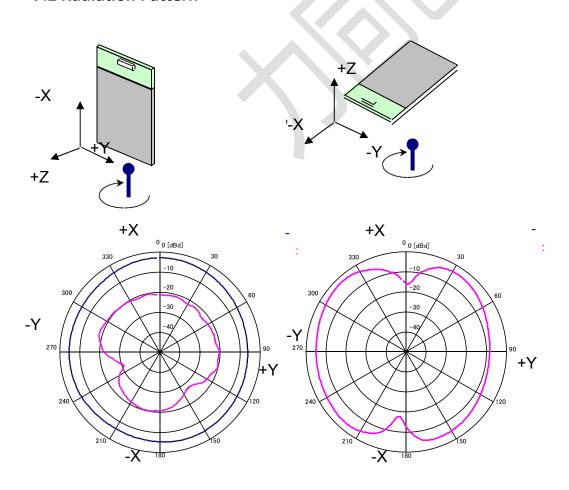
## **6.** PCB



## 7. Measurement Results Return Loss



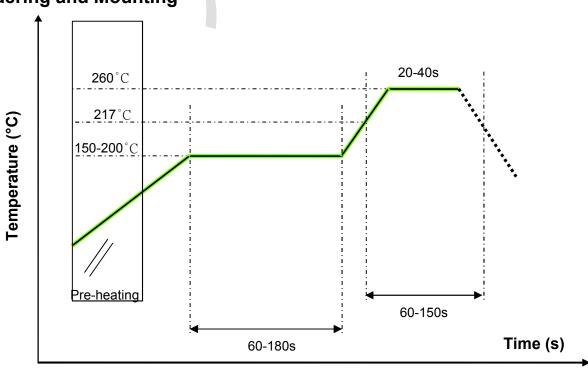
#### 7.2 Radiation Pattern



## 8. Reliability and Test Condictions

Test item	Test condition / Test method	Specification
Solderability	*Solder bath temperature: 235 ± 5°C	At least 95% of a surface of each terminal
JIS C 0050-4.6	*Immersion time : $2 \pm 0.5$ sec	electrode must be covered by fresh solder.
JESD22-B102D	Solder : Sn3Ag0.5Cu for lead-free	
Leaching (Resistance to dissolution of metallization) IEC 60068-2-58	*Solder bath temperature: $260 \pm 5^{\circ}\text{C}$ *Leaching immersion time: $30 \pm 0.5 \text{ sec}$ Solder: SN63A	Loss of metallization on the edges of each electrode shall not exceed 25%.
Bending test JIS C 0051- 7.4.1	The middle part of substrate shall be	No mechanical damage.
	pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 1mm/s and then pressure shall be maintained for 5±1 sec.  Measurement to be made after keeping at room temperature for 24±2 hours	Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
Resistance to soldering heat  JIS C 0050-5.4	*Preheating temperature : 120~150°C,  1 minute.  *Solder temperature: 270±5°C  *Immersion time : 10±1 sec  Solder : Sn3Ag0.5Cu for lead-free  Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage.  Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.  Loss of metallization on the edges of each electrode shall not exceed 25%.

## 9. Soldering and Mounting



#### 11. Storage and Transportation Information

#### **Storage Conditions**

To maintain the solderability of terminal electrodes:

- 1. Temperature and humidity conditions: -10~ 40°C and 30~70% RH.
- Recommended products should be used within 6 months from the time of delivery.
- The packaging material should be kept where no chlorine or sulfur exists in the air.

#### **Transportation Conditions**

- Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- The use of tweezers or vacuum pick up is strongly recommended for individual components.
- Bulk handling should ensure that abrasion and mechanical shock are minimized.

## 12. Packing

P

- (1) Quantity/Reel: 2000 pcs/Reel
- (2) Plastic tape:

## a. Tape Drawing

# Po PZ B B C

b. Tape Dimensions (unit: mm)

Feature	Specifications	Tolerances
W	12.00	±0.30
Р	4.00	±0.10
Е	1.75	±0.10
F	5.50	±0.10
P2	2.00	±0.10
D	1.50	+0.10 -0.00
Po	4.00	±0.10
10Po	40.00	±0.20

c. Reel Drawing

В

